



LDO (U2)  
VIN= 5.5V  
MAX  
VOUT=3.3V

To Use R1 Instead of U4 and R4:  
-Remove U4 and R4;  
-Shunt pin 4 and 3  
-Place R1 (0201) on pads 4 and 1

All RF ports except ANT have DC block internally  
All RF traces will be 50 ohm Microstrip

PCB Number: TIDA-00897  
PCB Rev: E1  
PCB LOGO  
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